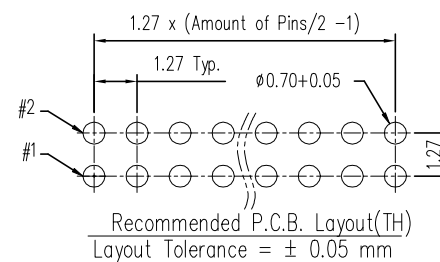





## NOTE:

1. MATERIAL,  
HOUSING: HIGH TEMP THERMAL PLASTIC, UL94-V0  
TERMINAL: COPPER ALLOY
2. FINISH:  
TERMINAL: 40u" MIN Ni UNDER PLATING
3. SPEC.:  
PRODUCT SPEC: GS-12-629  
PACKING SPEC: GS-14-1517
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C  
PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION.
5. MATING SIDE LENGTH: 2.5MM MIN.
6. PRODUCT NUMBERING:  
20021822 - XXX XX X X LF  
LEAD FREE  
PLATING:  
0: 80~200u" TIN ALL OVER  
1: GOLD FLASH ALL OVER  
4: 10u" GOLD AT CONTACT, G/F ON THE OTHER AREA.  
8: 30u" GOLD AT CONTACT, G/F ON THE OTHER AREA.  
PACKING  
T: TUBE  
PIN COUNT  
04, 06, 08, ..., 98, A0  
( EVERY EVEN PIN )  
STACK HEIGHT "K"  
EXAMPLE: 045=4.5MM  
IN 0.5MM INCREMENT



mat'l. code				surface ASME Y14.5 / tolerance ASME Y14.5		projection 		product family MINITEK 1.27											
ltr	ecn no	dr	date	tolerances unless otherwise specified				title  VERTICAL STACK HEADER											
B	ELX-N-30567	TONY	2018-06-28	angles	linear .0±.38	mm													
					linear .00±.25														
				0°±x'	linear .000±.15	scale N.T.S.													
				dr	STERLING LIN	10'-5-20			dwg no		sheet 1 of 1				size				
				eng	STERLING LIN	10'-5-20			20021822		A4								
				chr	STERLING LIN	10'-5-20													
				app'd	GARY HSIEH	10'-5-20													
sheet index		revision sheet		B	1														